# Study of LGAD with high timing resolution



**CALICE** Analysis Meeting

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# Introduction

### ILD and ECAL

#### ILD (International Large Detector)

- $\succ$  Detector to be placed at the collision point of the ILC
- > Main components: Vertex, TPC, ECAL, HCAL, Coil

#### SiW-ECAL

- Sandwich calorimeter (30 layers)
- Absorption layers : Tungsten

Detection layers : Si (Pixel size:  $5 \times 5 mm^2$ )

or Scintillator





5.5 mm x 256 pixels



### Particle ID of hadrons and timing resolution

#### Particle ID of hadrons

- > Only measurement of dE/dx and momentum
  - ID of K/ $\pi$  ~ 3 $\sigma$  ID of K/p < 2 $\sigma$
  - There exists momentum ranges where we can't identify: I-3 GeV
- Better separation power can be obtained by adding Time-of-Fright (ToF)
- > Possible to separate (5 $\sigma$ )  $\pi$ /K up to 4 GeV by 20 ps ToF with dE/dx



- > ECAL with standard Si: ~100 ps up to 3 GeV (3  $\sigma$ )
- > LGAD: 20–30 ps up to 5 GeV (3  $\sigma$ )

 $\rightarrow$ we are planning to use LGAD to replace sensor of a part of ECAL



### Type of LGAD

#### LGAD (Low Gain Avalanche Detector)

- > Silicon sensor with internal avalanche multiplication mechanism
- > Studies of LGAD in ATLAS group have achieved timing resolution of about 26 ps



Reach-through type

- Multiplication area is not uniformly formed
- Amplification ratio depends on the hit position of the particle

#### Inverse type



- Multiplication area is uniformly formed
- > Uniform response is expected regardless of the hit position

# Test beam with Skirok2-CMS

### Test beam with Skirok2-CMS

#### Test beam 16-19 Feb. 2021 at ELPH, Tohoku University

- Positron beam, ~700 MeV
- Main purpose : Study of timing measurement of Avalanche photo diode (APD has the same structure as LGAD)



### Result : ADC distribution



red is clearly separated from the pedestal (black)

trigger threshold is higher than average signal

 $\rightarrow$  ~100% of the signal hits cause detectable signal  $\rightarrow$  need to reduce the noise to lower the threshold

### Result: timing resolution

Timing correlation of two APDs (channel 36 and 39)



• Jitters of Skiroc2-CMS are large in the lower signal strength

(jitter is ~200 ps with 75 fC charge of signal)

• to achieve timing resolution 30 ps by noise reduction is difficult...  $\rightarrow$  need another reading system

# Test beam with discrete AMP

### Test beam with discrete amplifier



APD No.	Type of APD	<i>V<sub>br</sub></i> [V]	size [mm]	capacity [pF]
S8664-50K	Inverse	416	5φ	55 <sub>P</sub> F
S2385	Reach through	160	5φ	95 <sub>P</sub> F

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### Analysis method

#### Set up

• The signals from the two APDs (APD1 and APD2) amplified by the amp. board are directly acquired and analyzed by an oscilloscope.

#### Analysis method

- signal from APD1  $\rightarrow$  ch1(20 mV/div) and ch2(2 mV/div)
- signal from APD2  $\rightarrow$  ch3(20 mV/div) and ch4(2 mV/div)
- Ch1 and ch3: obtain waveform height and timing information for large signals
- Ch2 and ch4: Obtain more detailed timing information

for small signals





Oscilloscope



MSO 4104 (Tektronix) • IGHz, 5GS/s

Obtain the timing at the point where the voltage is 50 % of the wave height →Estimate the timing resolution from the time difference between the two APDs.



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### Result of timing resolution



#### Timing resolution of S8664-50K is better

 $\rightarrow$  Difference in capacitance related to signal rising time (S8664-50K:55 pF S2385:95 pF)

#### Evaluation of timing jitter due to noise

• Pedestal variation as a noise effect,

add this effect to the pedestal, wave height, and 50% of wave height points

- Events with charge > 18 fC S8664-50K: 120 ps, S2385: 200 ps
- Events with charge > 36 fC S8664-50K: 62 ps, S2385: 106 ps
- Most of the time resolution is affected by noise caused by sensors and readout circuits



#### Relation between Charge of signal and Timing jitter due to noise



Result

### For achieve high timing resolution

Timing resolution factors:  $\sigma_t^2 = \sigma_s^2 + \sigma_n^2$ 

- $\sigma_s^2$ : Uncertainty in the timing response of the sensor itself
  - > Landau noise: waveform changes depending on whether energy deposit occurs more on the upper side or lower side of the sensor.
    - $\rightarrow$  Making the sensitivity layer thinner decrease Landau noise, but the signal becomes smaller, so the S/N ratio becomes worse. (It seem that the thickness of sensitive layer of S8664-50K is 5  $\mu m$ )
  - > Avalanche amplification fluctuation: Uncertainty in time for accelerated electrons to knock out surrounding electrons
- $\sigma_n^2$ : Uncertainty caused by noise
  - > Capacitance of sensor: The smaller the capacitance of the sensor, the smaller the rise time of the waveform.

 $\rightarrow$  Capacitance is proportional to the size of the sensor  $\rightarrow$  Smaller sensors are less affected by noise.

- $\succ$  Thermal noise: caused by high temperatures in amplifiers and sensor  $\rightarrow$  need cooling
- > Noise due to disturbance to the conduction path between the sensor and the amplifier or due to HV

 $\rightarrow$  devise wiring, Stabilization of supply voltage, etc...

### Summary

- LGAD have high timing resolution  $\rightarrow$  Introduction of LGAD is expected to improve the timing resolution of ECAL
- Test beam with Skiroc2-CMS to measure the performance of APD
  - > Obtained timing resolution of inverse type APD (S8664-50K): 242 ps
  - > Jitter of Skiroc2-CMS are large in the lower signal strength
- Test beam with discrete amplifier to measure the performance of APD
  - > Achieved 63 ps timing resolution with inverse S8664-50K using only large signals
  - > Improved timing resolution by increasing the statistics of the large signal.
  - $\succ$  Increase the amount of charge by using an APD with a thicker sensitivity layer  $\rightarrow$  Decrease the Jitter
  - Use an oscilloscope with good performance
  - > Device to reduce noise...cooling of amplifier board, wiring etc...

# BACKUP

### Timing resolution of Skiroc2-CMS

- Timing resolution  $\cong$  (rising time)/(S/N ratio) + digitization jitter + Landau noise + timewalk
  - noise of Skirock2-CMS is large
  - rising time of Skiroc2-CMS fast shaper is large: 5 nsec
    - Value of S/N ratio ~250 required for 20 ps timing resolution equivalent to 600e- noise  $\rightarrow$  too difficult
    - Fast shaper can be faster but S/N degraded (need detailed study)
  - Digitization jitter of Skiroc2-CMS: ~30 ps
  - Landau noise: waveform changes depending on whether energy deposit occurs

more on the upper side or lower side of the sensor.

- Timewalk can be corrected (S.Tsumura's talk)
- Noise reduction by better HV treatment
  - However, to achieve timing resolution 30 ps by noise reduction is difficult...  $\rightarrow$  need another reading system

### Measurement with Skiroc2-CMS

#### ASIC for reading signals of silicon sensor

#### TOA (Time Of Arrival)

Timing information between the triggered

time and the next internal clock



#### ADC

> 13 cells waveform digitizer at 50 MHz

ring buffer



### Timewalk measurement

大きい信号

小さい信号

timewalk

TOA fall

TOA rise

閾値

#### Timewalk

- 入力された信号の大きさによって生じる時間情報の誤差
- 同じタイミングで入力されたとしても 大きい信号のほうが小さい信号より 閾値を超えるタイミングが早くなるため 時間情報に誤差が生じる
- テストボードを用いてInjection信号の電圧を変えながら
  その時のTOAを記録することで、Timewalkを測定





TOAと入力信号の電荷の関係から、 timewalkが従う指数関数を決定

→実験データのtimewalk補正に使用